SN54150, SN54151A, SN54LS151, SN54S151, SN74150, SN74151A, SN74LS151, SN74S151 DATA SELECTORS/MULTIPLEXERS

DECEMBER 1972-REVISED MARCH 1988

- '150 Selects One-of-Sixteen Data Sources
- Others Select One-of-Eight Data Sources
- All Perform Parallel-to-Serial Conversion
- All Permit Multiplexing from N Lines to One Line
- Also For Use as Boolean Function Generator
- Input-Clamping Diodes Simplify System Design
- Fully Compatible with Most TTL Circuits

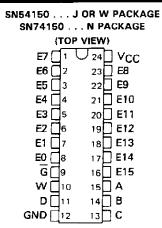
	TYPICAL AVERAGE	TYPICAL
TYPE	PROPAGATION DELAY TIME	POWER
	DATA INPUT TO W OUTPUT	DISSIPATION
150	13 ns	200 mW
151A	8 ns	145 mW
'LS151	13 ns	30 mW
'S151	4.5 ns	225 mW

description

These monolithic data selectors/multiplexers contain full on-chip binary decoding to select the desired data source. The '150 selects one-of-sixteen data sources; the '151A, 'LS151, and 'S151 select one-of-eight data sources. The '150, '151A, 'LS151, and 'S151 have a strobe input which must be at a low logic level to enable these devices. A high level at the strobe forces the W output high, and the Y output (as applicable) low.

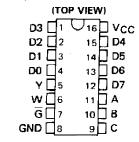
The '150 has only an inverted W output; the '151A, 'LS151, and 'S151 feature complementary W and Y outputs.

The '151A and '152A incorporate address buffers that have symmetrical propagation delay times through the complementary paths. This reduces the possibility of transients occurring at the output(s) due to changes made at the select inputs, even when the '151A outputs are enabled (i.e., strobe low).

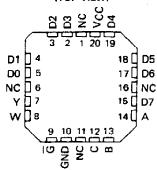


SN54151A, SN54LS151, SN54S151 . . . J OR W PACKAGE SN74151A . . . N PACKAGE

SN74LS151, SN74S151 . . . D OR N PACKAGE



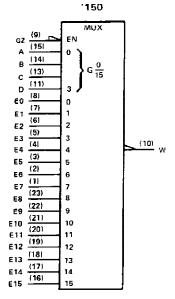
SN54LS151, SN54S151 . . . FK PACKAGE (TOP VIEW)

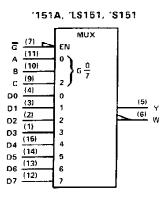


NC - No internal connection

SN54150, SN54151A, SN54LS151, SN54S151, SN74150, SN74151A, SN74LS151, SN74S151 DATA SELECTORS/MULTIPLEXERS

logic symbols†





'150 FUNCTION TABLE

		INI	PUT	S	OUTPUT
	SEL	ECT	•	STROBE	w
D	С	В	_A	Ğ	VV
Х	X	Х	Х	Н	Ŧ
L	L	L	L	L	ΕÖ
L	L	L	H	L	E1
L	L	H	L	L	E2
L	L	Н	н	L	Ē3
L	Н	L	L	L,	Ē4
L	Н	L	Η :	L	E5
L	н	Н	L.	L	<u>E6</u>
L	н	Н	н	L	E7
н	L	L	Ł	L	€8
Н	L	L	Н	L	Ē9
Н	L	н	L	L	E10
н	L	Н	н	L	E11
н	н	L	L	L	E12
н	Н	L	н	L	E13
н	Н	Н	L	L	E14
н	н	н	н	L	E15

'151A, 'LS151, 'S151 FUNCTION TABLE

	11	VPUT	S	OUT	PUTS
S	ELEC	T	STROBE	v	w
C	В	Α	Ğ	*	**
Х	Х	Х	Н	L	I
L	L	L	L	DO	<u>500</u>
L	L	Н	L	D1	D1
L	Н	L	L	D2	D2
L	н	Н	L	D3	D3
Н	L	L	L	D4	D4
Н	L	H	L	D5	D5
Н	н н Ļ		L	D6	D6
Н	Н	н	L	D7	D7

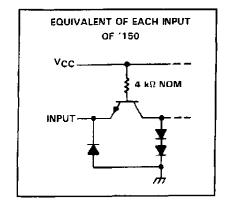
H = high level, L = low level, X = irrelevant

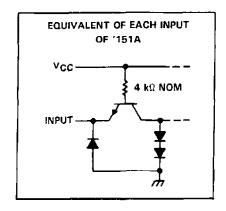
 $\overline{\text{E0}}$, $\overline{\text{E1}}$. . . $\overline{\text{E15}}$ = the complement of the level of the respective E input

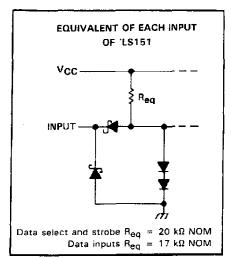
DO, D1 . . . D7 = the level of the D respective input

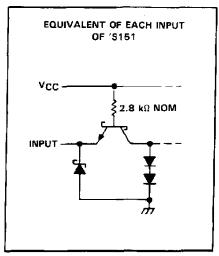
[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are D, J, N, and W packages.

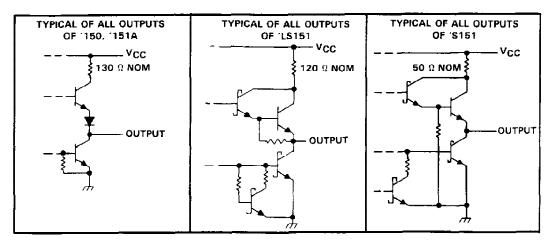
schematics of inputs and outputs











SN54150, SN54151A, SN74150, SN74151A DATA SELECTORS/MULTIPLEXERS

recommended operating conditions

		SN54'			SN74'		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH		-	-800			-800	μА
Law-level output current, IOL			16			16	mΑ
Operating free-air temperature, TA	-55		125	0		70	C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	CA CAMPTED	TEST CONDI	TIONST		1150			151A		UNIT
	PARAMETER 	TEST CONDI	TIONS.	MIN	TYP [‡]	MAX	MIN	TYP‡	MAX	UNII
VιΗ	High-level input voltage			2			2			٧
VIL	Low-level input voltage			•		0.8			0.8	٧
VIK	Input clamp voltage	VCC = MIN. I	= -8 mA			- 1.5			-1.5	V
∨он	High-level output voltage	$V_{CC} = MIN, V_{H}$ $V_{IL} = 0.8 \text{ V}, I_{OI}$	· 1	2.4	3.4		2.4	3.4		V
VOL	Low-level output voltage	$V_{CC} = MIN, V_{II}$ $V_{IL} = 0.8 \text{ V}, I_{OI}$			0.2	0.4		0.2	0.4	٧
l _j	Input current at maximum input voltage	VCC = MAX, V	= 5.5 V			1 ,			1	mΑ
lite	High-level input current	VCC = MAX, VI	= 2.4 V			40			40	μА
l _{IL}	Low-level input current	$V_{CC} = MAX, V_I$	= 0.4 V		·	-1.6			-1.6	mA
		14 MAN	SN54'	- 20		- 55	- 20		- 55	
los	Short-circuit output current ⁹	V _{CC} = MAX	SN74'	- 18		- 55	-18		- 55	mA
lcc	Supply current	V _{CC} = MAX, See	Note 3		40	68		29	48	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

switching characteristics, VCC = 5 V, TA = 25°C

	FROM	то	TEST	,	150			151/	4	
PARAMETER ¶	(INPUT)	(OUTPUT)	CONDITIONS	MIN 7	TYP	MAX	MIN	TYP	MAX	UNIT
tPLH	A, B, or C	Y						25	38	
[†] PHL	(4 levels)] '						25	38	пş
tPLH	A, B, C, or D	w			23	35		17	26	ns
^t PHL	(3 levels)	,			22	33		19	30	1115
tPLH	Strobe G	Y	CL = 15 pF,					21	33	ns
tPHL .	Strone G		$R_L = 400 \Omega$					22	33	1115
tPLH	Strobe \vec{G}	w	See Note 4	1	5.5	24		14	21	ns
tPH L	Strope G	**	200 17013 17		21	30		15	23	,''\$
†PLH	DO thru D7	Y						13	20	
₹PHL	Bo till a D							18	27	ns
tPLH	E0 thru E15, or	W			8.5	14		8	14	
tPHL .	D0 thru D7				13	20		8	14	ns

 $f_{\text{tpLH}} = \text{propagation delay time, low-to-high-level output}$ $t_{\text{pHL}} = \text{propagation delay time, high-to-low-level output}$

[†] All typical values at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$.

Not more than one output of the '151A should be shorted at a time.

NOTE 3: ICC is measured with the strobe and data select inputs at 4.5 V, all other inputs and outputs open.

NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

	S	N54LS	151	Si	N74LS1	51	LINICT
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	b,b	4.75	5	5.25	٧
High-level output current, IOH			-400			-400	μА
Low-level output current, IOL			4			8	mA
Operating free-air temperature, TA	-65		125	0		70	C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DAGAMETEO	TEST CONDIT	unant.	s	N54LS1	 51	s	N74LS1	51	UNIT
	PARAMETER	TEST CONDIT	IONS.	MIN	ΤΥ₽ [‡]	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage			2			2			٧
VIL	Low-level input voltage					0.7			0.B	٧
Vik	Input clamp voltage	V _{CC} - MIN, I _f = -1	8 mA			- 1.5			-1.5	٧
Vон	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V _{IL} = V _{IL} max, I _{OH} =		2.5	3.4		2.7	3.4		٧
VoL	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V _{II} = V _{II} max	2 V, I _{OL} = 4 mA I _{OL} = 8 mA		0.25	0.4		0.25 0.35	0.4 0.5	٧
l _į	Input current at maximum input voltage	$V_{CC} = MAX$, $V_1 = 7$				0.1			0.1	mA
ЧН	High-level input current	$V_{CC} = MAX$, $V_1 = 2$.	7 V			20			20	μΑ
IIL	Low-level input current	$V_{CC} = MAX$, $V_{I} = 0$.	4 V			-0.4			-0.4	mA
los	Short-circuit output current§	V _{CC} = MAX		- 20		- 100	- 20		- 100	mΑ
lcc	Supply current	V _{CC} = MAX, Outputs All inputs at 4.5 V	open,		6.0	10		6.0	10	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

switching characteristics, VCC = 5 V, TA 25 °C

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
[†] PLH	A, B, or C	Y			27	43	
tPHL	(4 levels)	ı .			18	30	ns
tPLH	A, B, or C	W	1		14	23	
tPHL	(3 levels)				20	32	ns
^t PLH	Strobe G	Y	0. 15.5		26	42	
t _{PHL}	2 strope G	irobe d	C _L = 15 pF,		20	32	ns
[†] PLH	Strobe G	W	R _L = 2 kΩ,		15	24	
tpHL	Strope G	W See Note 4	18	30	ns		
t _{PLH}]		20	32	
tpHL	Any D	Y	İ		16	26	ns
tPLH	A D	w			13	21	
[†] PHL	Any D	vv			12	20	ns



 $^{^{\}ddagger}$ All typical values are at V_{CC} = 5 V, T_A = 25 °C. $^{\$}$ Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second.

[¶]tpLH = propagation delay time, low-to-high-level output tpHL = propagation delay time, high-to-low-level output NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

SN54S151, SN74S151 DATA SELECTORS/MULTIPLEXERS

recommended operating conditions

	S	N54S1	51		N74S1	51	
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH		_	-1			-1	mA
Low-level output current, IOL			20			20	πА
Operating free-air temperature, TA	55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONST		MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage			2			V
VIL	Low-level input voltage					0.8	V
Vik	Input clamp voltage	V _{CC} = MIN, I _I = -18 mA				-1.2	V
· · · · ·	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V,	SN54S151	2.5	3.4		
νон	riign-rever ou tout vortage	VIL = 0.8 V, IOH = -1 mA	SN74S151	2.7	3.4		V
VOL	Low-level output voltage	VCC = MIN, VIH = 2 V,	-			a c	v
VOL	Low-level output voltage	V _{IL} = 0.8 V, I _{OL} = 20 mA	i			0.5	v
l _k	Input current at maximum input voltage	VCC = MAX, V1 = 5.5 V				1	mA
ΉН	High-level input current	V _{CC} = MAX, V _I = 2.7 V				50	μА
1 _{IL}	Low-level input current	V _{CC} - MAX, V _I = 0.5 V				-2	mA
los	Short-circuit output current 8	V _{CC} = MAX		-40		-100	mA
¹cc	Supply current	VCC = MAX, All inputs at 4.5 V,			45	70	mA
		All outputs open	Ī		. •		,

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device

switching characteristics. V_{CC} = 5 V. T_A 25 °C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PLH	A, B, or C	Y	•		12	18	
^t PHL	(4 levels)	ţ	ļ		12	18	ns
tPLH	A, B, or C	w	1		10	15	
[†] PHL	(3 levels)				9	13.5	ns
tPLH	Any D	Y	G 45-5		8	12	
₹PHL	Any	,	C _L = 15 pF,		8	12	ns
tpLH	Any D	W	R _L = 280 kΩ, See Note 4		4.5	7	ns
tPHL	T ANY D	VV	See Note 4			7	
tpLH	Strobe G	Y			11	16.5	
tphL	3trope G	т			12	18	ns
^t PLH	Strobe G	w			9	13	
tPHL	Strope G				8.5	12	กร

TtpLH = propagation delay time, low-to-high-level output



 $[\]ddagger$ All typical values are at \lor CC = 5 \lor , \lnot A = 25°C. \ddagger Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

tpHL - propagation delay time, high-to-low-level output
NOTE 4: Load circuits and voltage waveforms are shown in Section 1.





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PACKAGING INFORMATION

Orderable Device	Status	Package Type		Pins		Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)		(3)		(4/5)	
5962-9558001QJA	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9558001QJ A SNJ54150J	Samples
5962-9558001QKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9558001QK A SNJ54150W	Samples
5962-9558001QKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9558001QK A SNJ54150W	Samples
5962-9751601QCA	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	-55 to 125		
76010012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	76010012A SNJ54LS 151FK	Samples
76010012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	76010012A SNJ54LS 151FK	Samples
7601001EA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601001EA SNJ54LS151J	Samples
7601001EA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601001EA SNJ54LS151J	Samples
7601001FA	NRND	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601001FA SNJ54LS151W	
7601001FA	NRND	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601001FA SNJ54LS151W	
JM38510/01401BKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 01401BKA	Samples
JM38510/01401BKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 01401BKA	Samples
JM38510/07901BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 07901BEA	Samples
JM38510/07901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 07901BFA	Samples
JM38510/30901B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30901B2A	Samples





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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/30901B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30901B2A	Samples
JM38510/30901BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30901BEA	Samples
JM38510/30901BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30901BEA	Samples
JM38510/30901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30901BFA	Samples
JM38510/30901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30901BFA	Samples
M38510/01401BKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 01401BKA	Samples
M38510/01401BKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 01401BKA	Samples
M38510/07901BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 07901BEA	Samples
M38510/07901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 07901BFA	Samples
M38510/30901B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30901B2A	Samples
M38510/30901B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30901B2A	Samples
M38510/30901BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30901BEA	Samples
M38510/30901BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30901BEA	Samples
M38510/30901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30901BFA	Samples
M38510/30901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30901BFA	Samples
SN54150J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54150J	Samples
SN54150J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54150J	Samples
SN54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS151J	Samples





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Orderable Device	Status	Package Type	•	Pins	_	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)		(3)		(4/5)	
SN54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS151J	Samples
SN54S151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54S151J	Samples
SN54S15J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	-55 to 125		
SN74150N	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74150N	Samples
SN74150N	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74150N	Samples
SN74150NE4	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74150N	Samples
SN74150NE4	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74150N	Samples
SN74151AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70		
SN74151AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70		
SN74LS151D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples





.com 25-Sep-2013

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS151DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	0 to 70		
SN74LS151J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	0 to 70		
SN74LS151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS151N	Samples
SN74LS151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS151N	Samples
SN74LS151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70		
SN74LS151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70		
SN74LS151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS151N	Samples
SN74LS151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS151N	Samples
SN74LS151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS151	Samples
SN74LS151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS151	Samples
SN74LS151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS151	Samples
SN74LS151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS151	Samples
SN74LS151NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS151	Samples
SN74LS151NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS151	Samples
SN74S151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74S151N	Samples
SN74S151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74S151N	Samples
SN74S151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70		
SN74S151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70		





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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74S151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74S151N	Samples
SN74S151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74S151N	Samples
SNJ54150J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9558001QJ A SNJ54150J	Samples
SNJ54150J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9558001QJ A SNJ54150J	Samples
SNJ54150W	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9558001QK A SNJ54150W	Samples
SNJ54150W	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9558001QK A SNJ54150W	Samples
SNJ54LS151FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	76010012A SNJ54LS 151FK	Samples
SNJ54LS151FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	76010012A SNJ54LS 151FK	Samples
SNJ54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601001EA SNJ54LS151J	Samples
SNJ54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601001EA SNJ54LS151J	Samples
SNJ54LS151W	NRND	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601001FA SNJ54LS151W	
SNJ54LS151W	NRND	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7601001FA SNJ54LS151W	
SNJ54S151FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54S 151FK	Samples
SNJ54S151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54S151J	Samples
SNJ54S151W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54S151W	Samples
SNJ54S15FK	OBSOLET	E LCCC	FK	20		TBD	Call TI	Call TI	-55 to 125		



PACKAGE OPTION ADDENDUM

25-Sep-2013

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)		(3)		(4/5)	
SNJ54S15J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	-55 to 125		
SNJ54S15W	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI	-55 to 125		

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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OTHER QUALIFIED VERSIONS OF SN54150, SN54LS151, SN54S15, SN54S151, SN74150, SN74LS151, SN74S151:

Catalog: SN74150, SN74LS151, SN74S15, SN74S151



PACKAGE OPTION ADDENDUM

25-Sep-2013

• Military: SN54150, SN54LS151, SN54S151

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

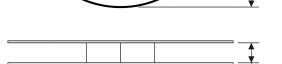
PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION

REEL DIMENSIONS





TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS151DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS151NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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*All dimensions are nominal

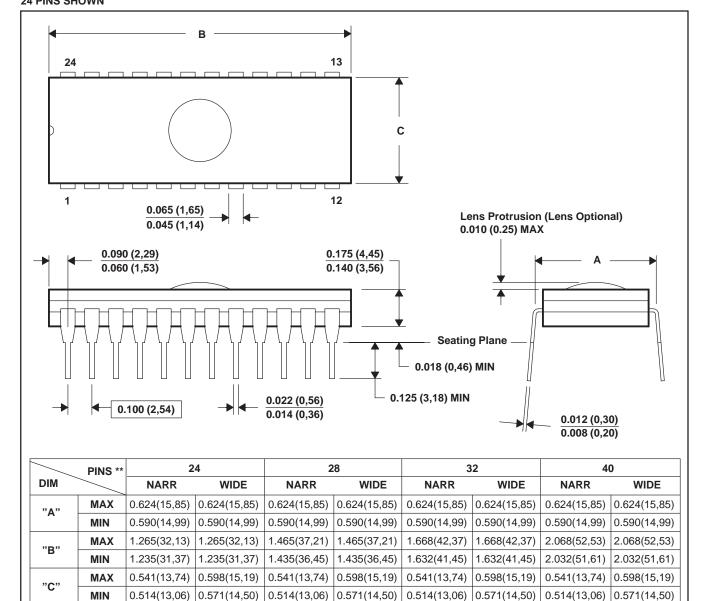
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS151DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS151NSR	SO	NS	16	2000	367.0	367.0	38.0

4040084/C 10/97

J (R-GDIP-T**)

24 PINS SHOWN

CERAMIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Window (lens) added to this group of packages (24-, 28-, 32-, 40-pin).
- D. This package can be hermetically sealed with a ceramic lid using glass frit.
- E. Index point is provided on cap for terminal identification.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK

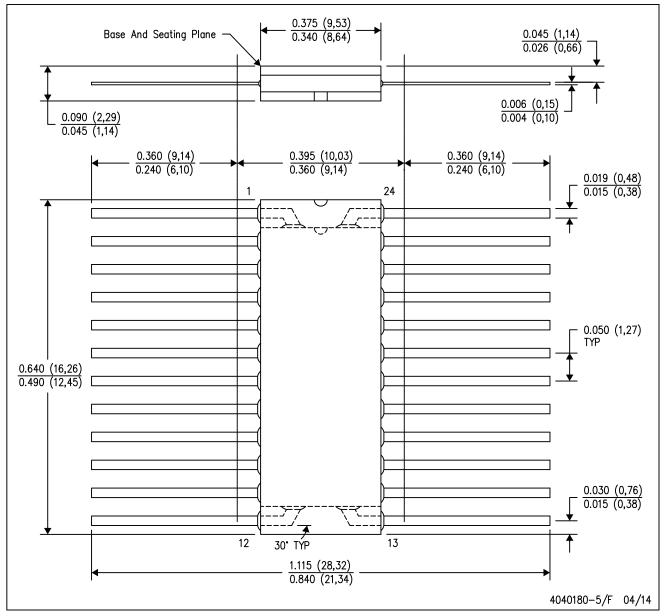


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



W (R-GDFP-F24)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only. E. Falls within Mil—Std 1835 GDFP2—F20



FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

24 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-011
- D. Falls within JEDEC MS-015 (32 pin only)



D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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